

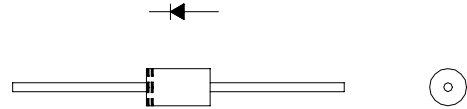
# DIODE Type : 30PUA60

OUTLINE DRAWING

**3A 600V 32ns**

## FEATURES

- \* Ultra-Fast Recovery
- \* Low Forward Voltage drop
- \* Low Reverse Leakage Current
- \* High Surge Capability



## Maximum Ratings

Approx Net Weight:1.21g

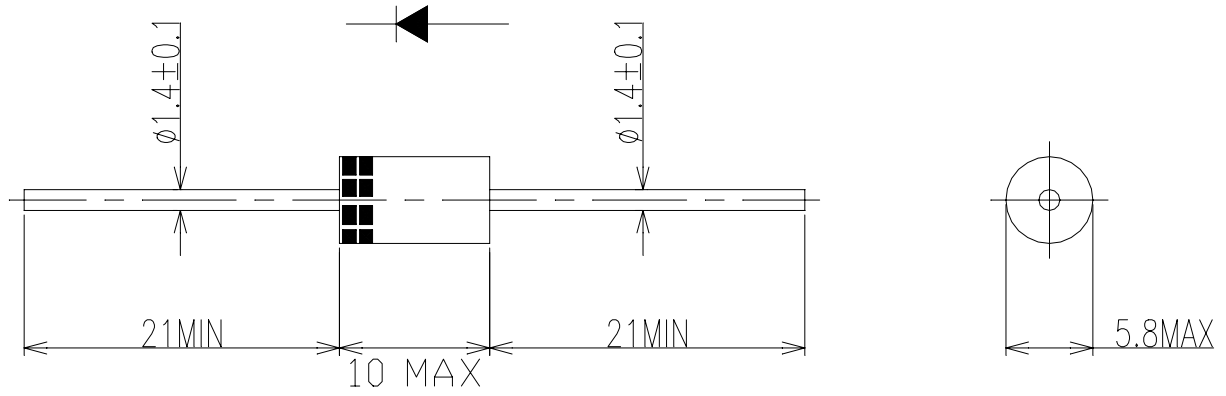
Rating	Symbol	30PUA60		Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	600		V
Average Rectified Output Current	$I_O$	50Hz Half Sine Wave Resistive Load	$T_a=30^{\circ}\text{C} *1$ 1.8	A
			$T_l=92^{\circ}\text{C}$ ( $T_l$ : Lead Temperature) 3.0	
RMS Forward Current	$I_{F(RMS)}$		4.71	A
Surge Forward Current	$I_{FSM}$	50Hz Half Sine Wave, 1 cycle, Non-repetitive		55 A
Operating Junction Temperature Range	$T_{jw}$	- 40 to + 150		$^{\circ}\text{C}$
Storage Temperature Range	$T_{stg}$	- 40 to + 150		$^{\circ}\text{C}$

## Electrical • Thermal Characteristics

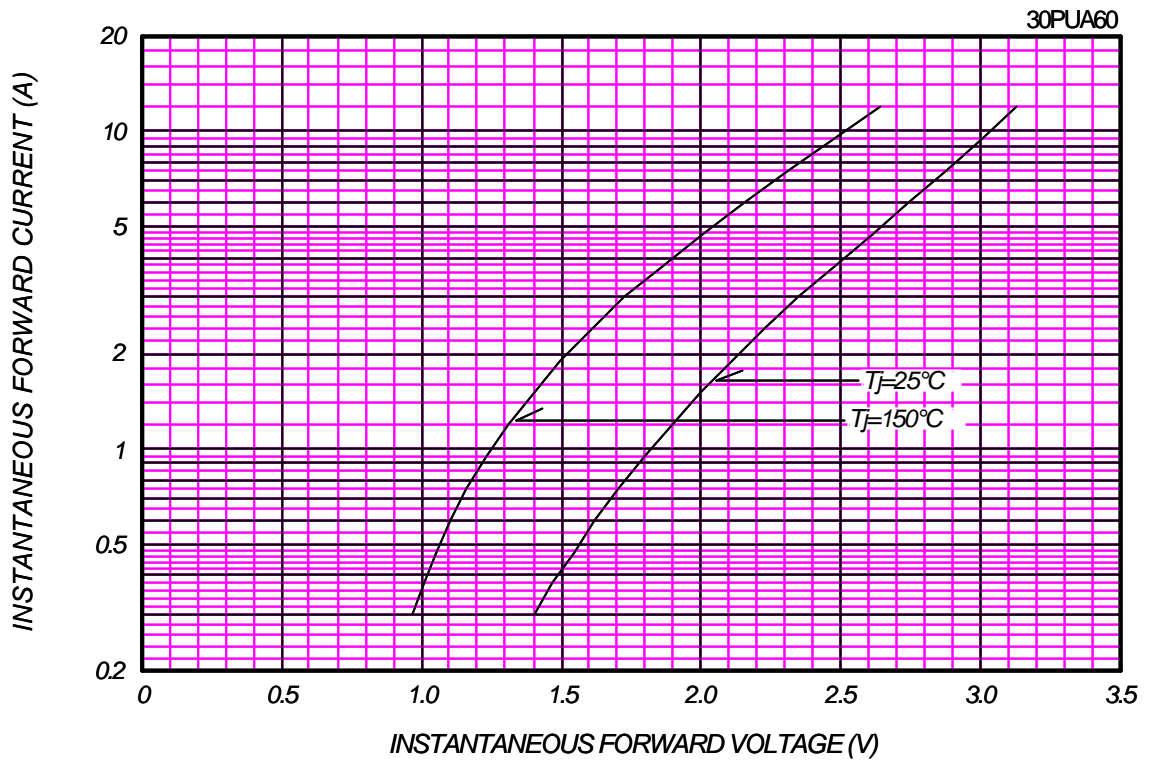
Characteristics	Symbol	Conditions	Min.	Typ.	Max.	Unit
Peak Reverse Current	$I_{RM}$	$T_j= 25^{\circ}\text{C}, V_{RM}= V_{RRM}$	-	-	20	$\mu\text{A}$
Peak Forward Voltage	$V_{FM}$	$T_j= 25^{\circ}\text{C}, I_{FM}= 3.0\text{A}$	-	-	2.35	V
Reverse Recovery time	$t_{rr}$	$T_j= 25^{\circ}\text{C}, I_{FM}= 3.0\text{A} -di/dt=50\text{V}$			32	ns
Thermal Resistance	$R_{th(j-a)}$	Junction to Ambient *1	-	-	34	$^{\circ}\text{C/W}$
	$R_{th(j-l)}$	Junction to Lead	-	-	8	

**1: With Cu Fin (20x20x1, L=5mm, Both Sides),**

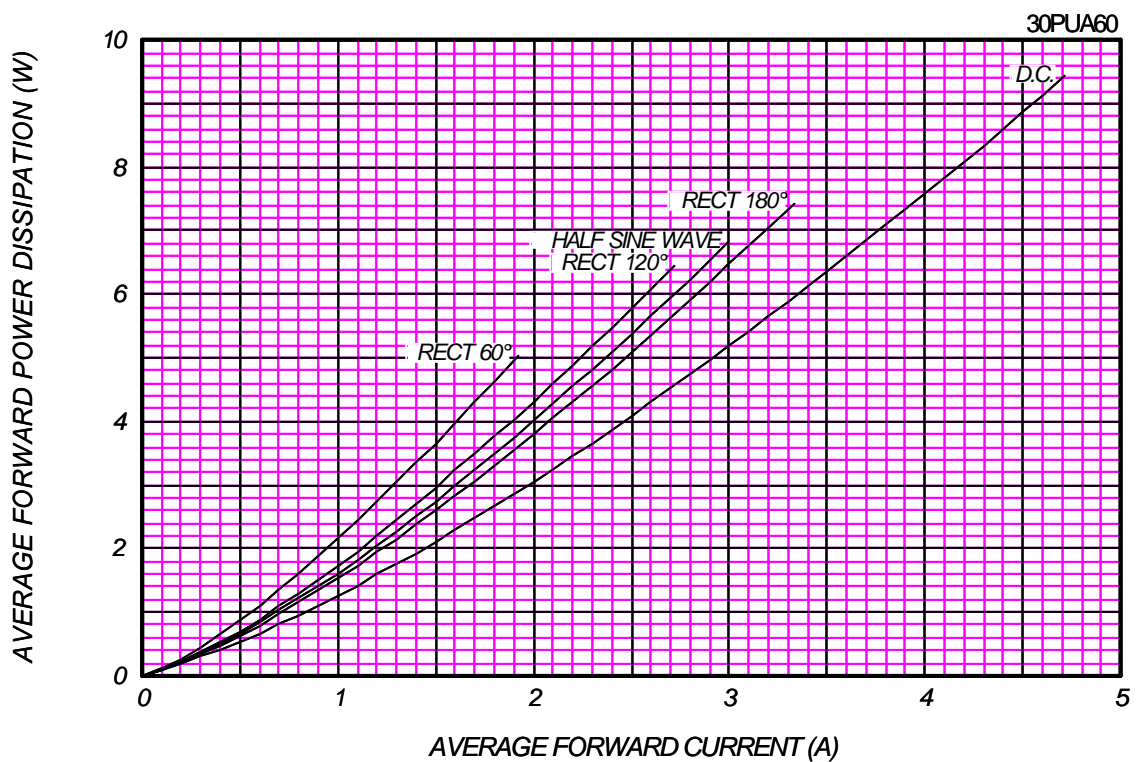
30PU\*\_ OUTLINE DRAWING (Dimensions in mm)



### FORWARD CURRENT VS. VOLTAGE



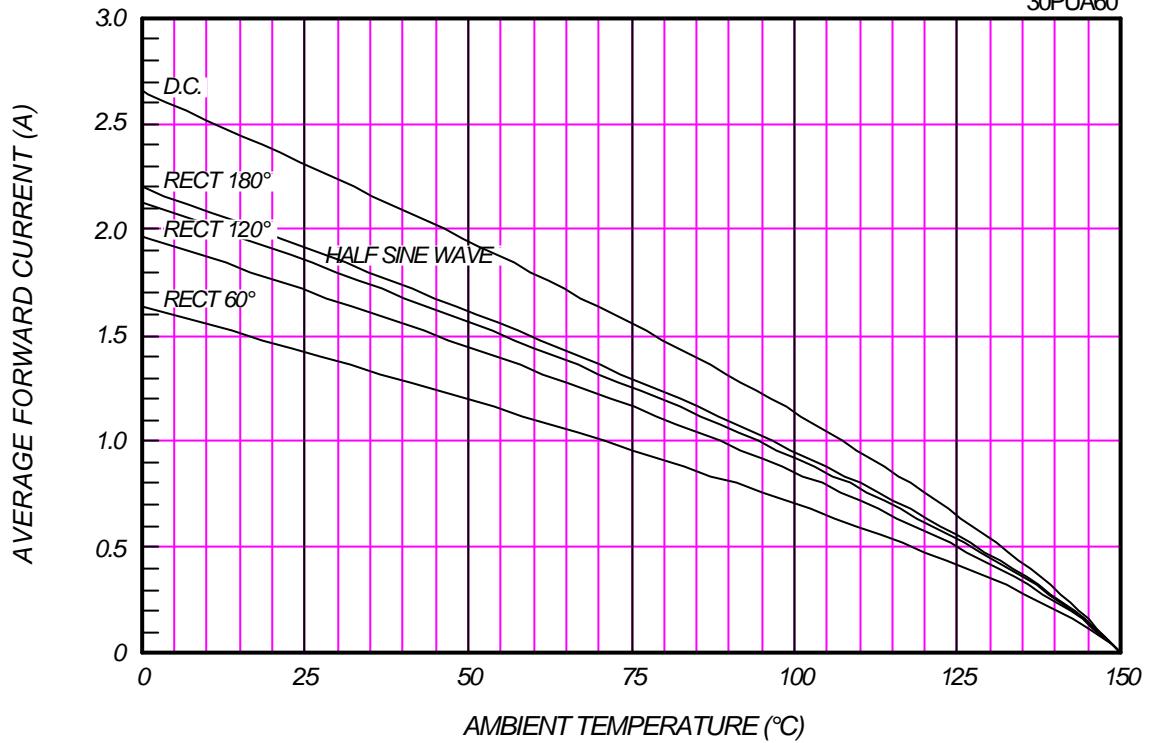
### AVERAGE FORWARD POWER DISSIPATION



### AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE

With Cu Fin (L=3mm,Print Land=5x5mm,Both Sides)

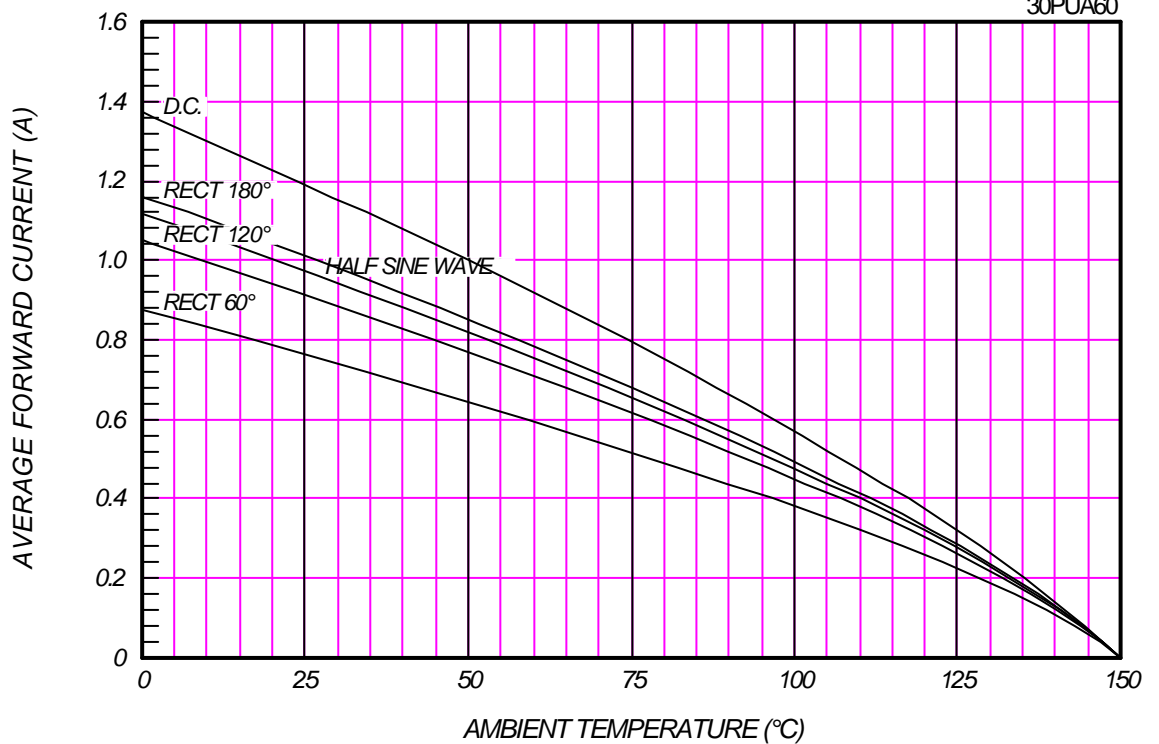
30PUA60



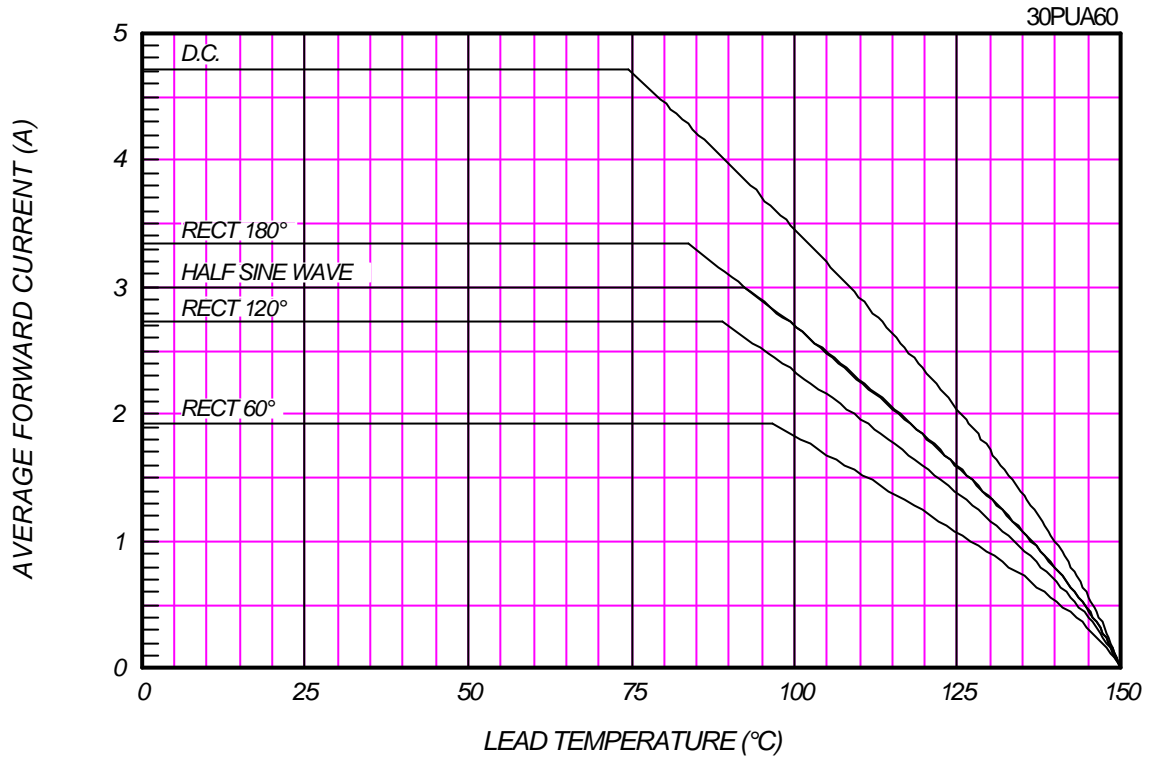
### AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE

Without Fin or P.C. Board

30PUA60



### AVERAGE FORWARD CURRENT VS. LEAD TEMPERATURE



### SURGE CURRENT RATINGS

f=50Hz, Half Sine Wave, Non-Repetitive, No Load

